

Features

- Patented coplanar structure DMC-Isolator®
- Peak Output Current: IOP = ±1A (max)
- Threshold Input Current: IFLH = 5 mA (max)
- Common mode transient immunity : ±25kV/µs (min)
- Under voltage lock out (UVLO) protection with hysteresis
- RoHS and REACH Compliance
- Halogen Free Compliance (Optional)
- MSL class 1
- Regulatory Approvals
 - ✓ UL UL1577 (E364000)
 - ✓ VDE EN60747-5-5(VDE0884-5)
 - ✓ CQC GB4943.1, GB8898(19001231775)
 - ✓ IEC62368 (FI/41119)

Description

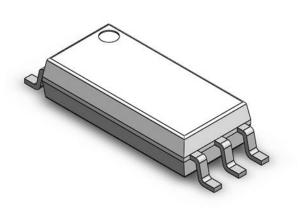
The CTL5701 consists of a LED optically coupled to an integrated circuit with a power output stage. This optocoupler is ideally suited for driving power IGBTs and MOSFETs used in motor control inverter applications. The high operating voltage range of the output stage provides the drive voltages required by gate-controlled devices.

CTL5701

Applications

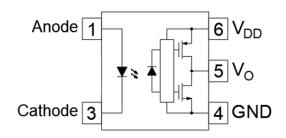
- Isolated IGBT/Power MOSFET gate drive
- Industrial Inverter
- AC brushless and DC motor drives
- Induction Heating

Package Outline



Note: Different lead forming options available. See package dimension.

Schematic



Truth Table					
	Vcc-V _{EE}	Vcc-V _{EE}			
LED	Positive Negative		Output		
	Going	Going			
Off	0 to 30 V	0 to 30V	Low		
On	0 to 6.9V	0 to 5.9V	Low		
On	6.9 to 8.7V	5.9 to 7.5V	Transition		
On	8.7 to 30V	7.5 to 30V	High		



CTL5701

Absolute Maximum Ratings $T_A = 25^{\circ}C$, unless otherwise specified

Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of this document. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only

Symbol	Parameters	Ratings	Units	Notes
Viso	Isolation voltage (AC, 1 minute, 40 ~ 60% R.H.)	5000	VRMS	
TOPR	Operating temperature	-40 ~ +110	0C	
Tstg	Storage temperature	-55 ~ +125	0C	
T _{SOL}	Soldering temperature (For 10 seconds)	260	0C	2
Ртот	Total power dissipation	300	mW	
Emitter				
lF	Forward current	25	mA	
IFP	Peak forward current (50% duty, 1ms P.W)	1	A	
VR	Reverse voltage	5	V	
Detector	•			•
PD	Power dissipation	250	mW	
Vo(peak)	Peak Output Voltage	0 to 30	V	1
I _{OPH}	Output High Peak Current	1	A	2
IOPL	Output Low Peak Current	1	A	2
Vcc	Supply voltage	0 to 30	V	3

Notes

- 1. The V_{O(PEAK)} voltage CAN NOT BE high than V_{CC}.
- 2. The I_o maximum pulse width = 10 μ s, maximum duty cycle = 0.2%.
- 3. The V_{CC} recommended operating condition is 10~30V.



Electrical Characteristics

Over recommended operating conditions TA = -40 to 110 °C. Typical values are measured at V_{CC} =30V, V_{EE} = GND, T_A = 25°C (unless otherwise stated)

Emitter Characteristics

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
VF	Forward voltage	IF = 10mA	-	1.45	1.8	V	
VR	Reverse Voltage	IR = 10µA	5.0	-	-	V	
A\/_/AT.	Temperature coefficient of	IF =10mA		10		mV/°C	
$\Delta V_F / \Delta T_A$	forward voltage	IF = IUMA	-	-1.8	-	mv/ C	

Detector Characteristics

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
Iccl	Logic Low Supply Current	$V_F = 0$ to 0.8V, $V_O = Open$	-	1.5	5		
Іссн	Logic High Supply Current	I _F = 7mA to 10mA, V _O = Open	-	1.5	5	mA	

Transfer Characteristics

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
Vон	High Level Output Voltage	I _F = 10mA, I _O = -100mA	Vcc-0.6	Vcc-0.4	-	V	
V _{OL}	Low Level Output Voltage	I _F = 0mA, I _O = 100mA	-	0.25	0.4	V	
I	High Lovel Output Current	Vo= Vcc-2V	-	-	-0.3		1
I _{OPH}	High Level Output Current	Vo= Vcc-4V	-	-	-1	A	1
	Level evel Output Current	V _O = V _{EE} +2V	0.3	-	-	A	1
IOPL	Low Level Output Current	Vo= VEE+4V	1	-	-		1
IFLH	Input Threshold Current	Io= 0mA, Vo> 5V	-	1.4	5.0	mA	
V _{FHL}	Input Threshold Voltage	I ₀ = 0mA, V ₀ < 5V	0.8	-	-	V	
V _{UVLO+}	Under Voltage Lockout	IO= 10mA, VO> 5V	6.9	7.8	8.7	V	
Vuvlo-	Threshold	IO= 10mA, VO< 5V	5.9	6.7	7.5	V	
UVLO _{HYS}	S Under Voltage Lockout Hysteresis		-	1.1	-	V	

Notes

1. The I_O maximum pulse width = 10 $\mu s,$ maximum duty cycle = 0.2%.



Electrical Characteristics

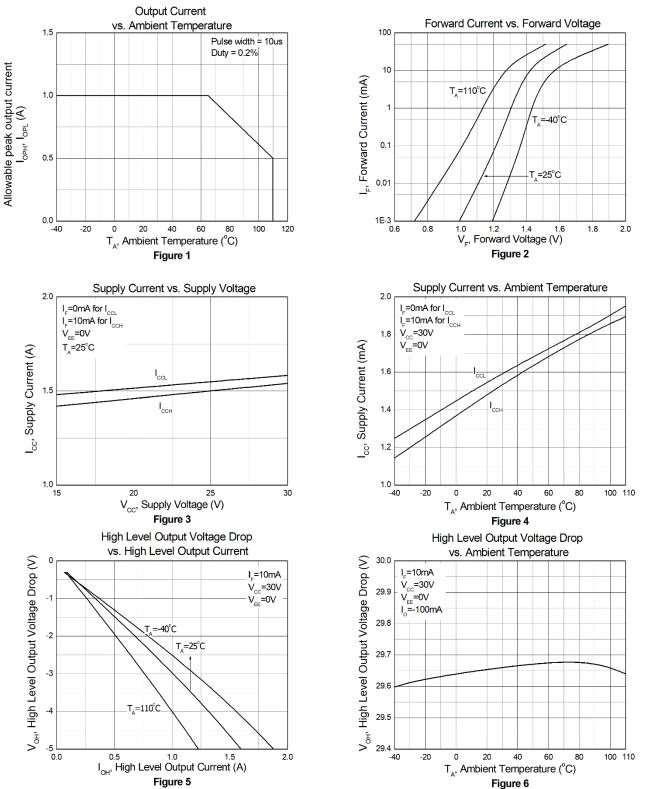
Over recommended operating conditions TA = -40 to 110 °C. Typical values are measured at V_{CC} =30V, V_{EE} = GND, T_A = 25°C (unless otherwise stated)

Switching Characteristics

Symbol	Parameters	Test C	onditions	Min	Тур	Max	Units	Notes
T _{PHL}	High to Low Propagation Delay			50	160	300	ns	
TPLH	Low to High Propagation Delay			50	140	300	ns	
Pwd	Pulse Width Distortion	- I _F = 7 to 16mA, C _L = 10nF, - R _L = 10Ω, f= 10kHz, Duty = - 50%, T _A = 25 ⁰ C			40	200	ns	
tрsк	Propagation Delay Skew					40	ns	
tr	Rise Time				20		ns	
t _f	Fall Time				20		ns	
tuvlo(on)	UVLO Turn On Delay	I _F = 10mA, V _O > 5V			3.5		μs	
tuvlo(off)	UVLO Turn Off Delay	I _F = 10mA, V _C	< 5V		3		μs	
CM _H	Common Mode Transient High	V _{CC} = 30V, T _A = 25 ⁰ C,	l⊧= 7 to 16mA	25			kV/µs	
CM∟	Common Mode Transient Low	V _{CM} = 1.5kV	IF= 0mA	25			kV/µs	



Typical Characteristic Curves T_A = 25°C, unless otherwise specified

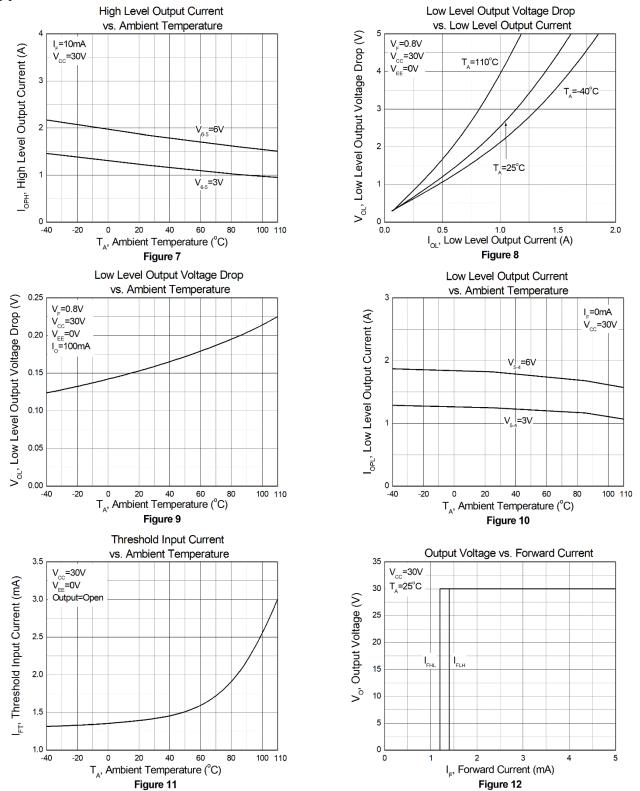




CTL5701

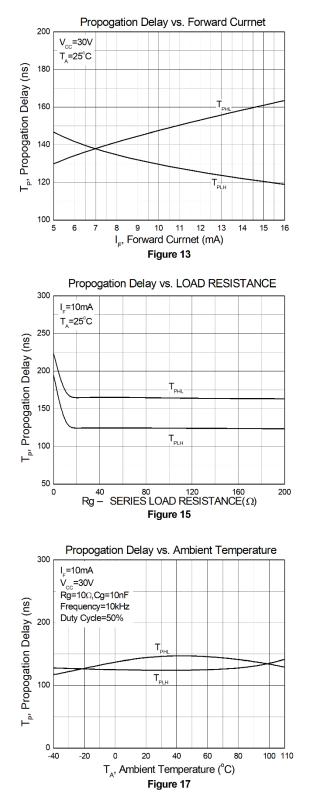
5-Pin Long Mini-Flat DMC-Isolator® 1A MOSFET/IGBT Gate Driver Optocoupler

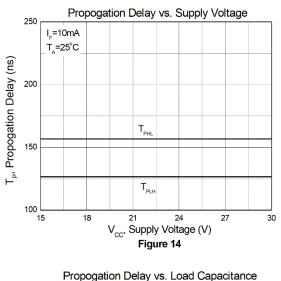


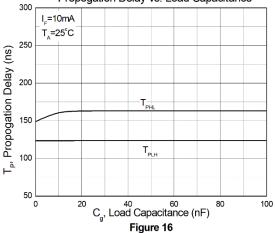




Typical Characteristic Curves T_A = 25°C, unless otherwise specified

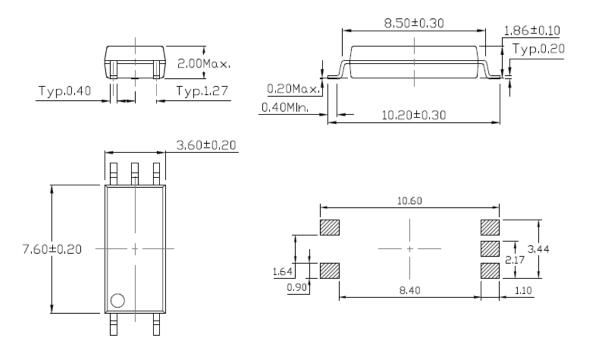








Package Dimension Dimensions in mm unless otherwise stated



Marking Information



Note:

- CT : Denotes "CT Micro"
- L5701 : Part Number
- V : VDE Safety Mark Option (Blank or V)
- Y : One Digit Year Code
- WW : Two Digit Work Week
- K : Manufacturing Code



5-Pin Long Mini-Flat DMC-Isolator®

1A MOSFET/IGBT Gate Driver Optocoupler

Ordering Information

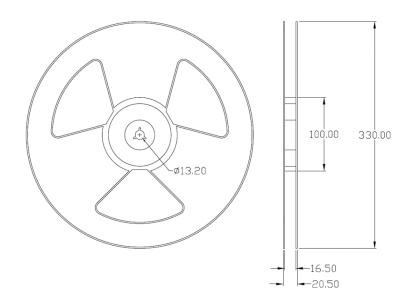
CTL5701(V)(Z)

- CT = Denotes "CT Micro"
- 5701 = Part Number
- V = VDE Safety Mark Option (Blank or V)
- Z = Tape and Reel Option (T1 or T2)

Option	Description	Quantity
T1	Surface Mount Lead Forming – With Option 1 Taping	3000Units/Reel
T2	Surface Mount Lead Forming – With Option 2 Taping	3000Units/Reel

Reel Dimension All dimensions are in mm, unless otherwise stated

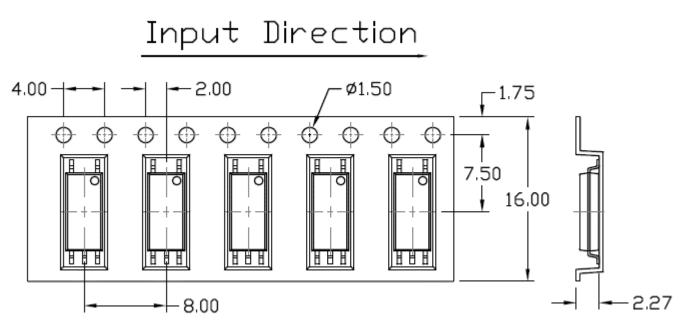
Option T1/T2



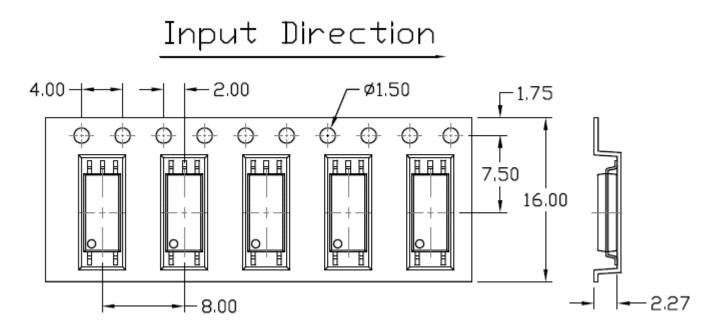


Carrier Tape Specifications Dimensions in mm unless otherwise stated

Option T1



Option T2





5-Pin Long Mini-Flat DMC-Isolator®

1A MOSFET/IGBT Gate Driver Optocoupler

Solderability spec (follow the JEDEC standard JESD22-B102)

Reflow Soldering: Immersed surface, other than the end of pin as cut-surface, must be covered by solder.

Solder-Bath: More than 95% of the electrode must be covered with solder.

Wave soldering (follow the JEDEC standard JESD22-A111)

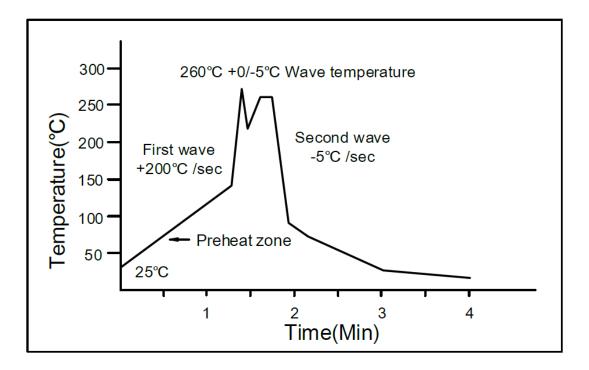
One time soldering is recommended within the condition of temperature.

Temperature: 260+0/-5°C.

Time: 10 sec.

Preheat temperature:25 to 140°C.

Preheat time: 30 to 80 sec.

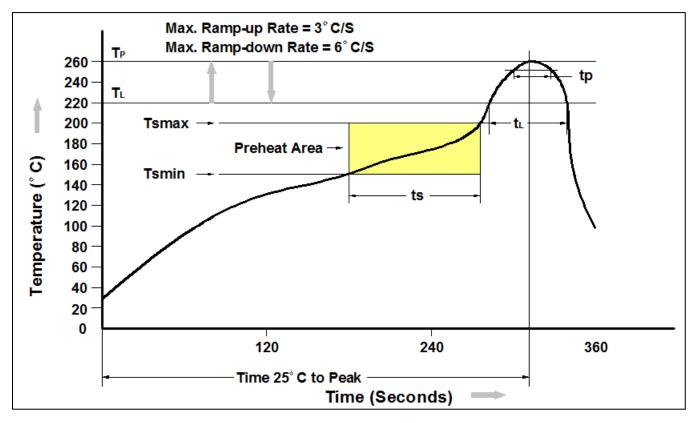


Iron soldering (follow the standard MIL-STD 202G, Method 210F)

Allow single lead soldering in every single process. One time soldering is recommended. Temperature: 350+±10°C Time: 5 sec max.



Reflow Profile (follow the JEDEC standard J-STD-020)



Profile Feature	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	150°C
Temperature Max. (Tsmax)	200°C
Time (ts) from (Tsmin to Tsmax)	60-120 seconds
Ramp-up Rate (t∟ to t⊳)	3°C/second max.
Liquidous Temperature (T _L)	217°C
Time (t _L) Maintained Above (T _L)	60 – 150 seconds
Peak Body Package Temperature	260°C +0°C / -5°C
Time (t _P) within 5°C of 260°C	30 seconds
Ramp-down Rate $(T_P \text{ to } T_L)$	6°C/second max
Time 25°C to Peak Temperature	8 minutes max.



CTL5701

DISCLAIMER

DMC-Isolator[®] IS A TRADEMARK OF CT MICRO INTERNATIONAL CORPORATION AND/OR ITS SUBSIDIARIES. CT MICRO OWNS THE RIGHTS TO A NUMBER OF PATENTS, TRADEMARKS, COPYRIGHTS AND OTHER INTELLECTUAL PROPERTY.

CT MICRO RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION OR DESIGN. CT MICRO DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS.

DISCOLORATION MIGHT OCCUR ON THE PACKAGE SURFACE AFTER SOLDERING, REFLOW OR LONG TERM USE. THIS DOES NOT IMPACT THE PRODUCT PERFORMANCE NOR THE PRODUCT RELIABILITY.

CT MICRO ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT EXPRESS WRITTEN APPROVAL OF CT MICRO INTERNATIONAL CORPORATION.

- Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instruction for use provided in the labelling, can be reasonably expected to result in significant injury to the user.
- A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.